A gate-tunable symmetric bipolar junction transistor fabricated via femtosecond laser processing†

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Two-dimensional (2D) bipolar junction transistors (BJTs) with van der Waals heterostructures play an important role in the development of future nanoelectronics. Herein, a convenient method is introduced for fabricating a symmetric bipolar junction transistor (SBJT), constructed from black phosphorus and MoS2, with femtosecond laser processing. This SBJT exhibits good bidirectional current amplification owing to its symmetric structure. We placed a top gate on one side of the SBJT to change the difference in the major carrier concentration between the emitter and collector in order to further investigate the effects of electrostatic doping on the device performance. The SBJT can also act as a gate-tunable phototransistor with good photodetectivity and photocurrent gain of $\beta = \sim 21$. Scanning photocurrent images were used to determine the mechanism governing photocurrent amplification in the phototransistor. These results promote the development of the applications of multifunctional nanoelectronics based on 2D materials.

Introduction

The development of microelectronics technology is inseparable from the 1951 invention of bipolar junction transistors (BJTs), which has helped to produce the digital revolution over the past half-century. A BJT, as a three-terminal (emitter, base and collector) device, is the fundamental building block of modern electronic devices, and its main feature is signal gain. These devices have been used in high-power amplifiers, high-frequency switches, analog circuits, and radio frequency (RF) systems, making them widely used in consumer electronics (e.g., communication products), computers, audio-visual systems, and sound equipment. Besides, low power BJTs have also been widely used for the small-signal applications of amplifiers, controllers, oscillators and switches, such as electronic ballasts and mobile phone chargers. With the progress of the modern industry and the development of nanotechnology, the applications of nano-dimensional integrated high-performance devices have become the trend of future electronics. As a result, BJTs based on traditional bulk materials, including silicon/silicon–germanium alloys, aluminum gallium arsenide/gallium arsenide, and indium phosphide/indium gallium arsenide, will be not able to meet the demand due to their difficult fabrication procedures and limited performance.

Two-dimensional (2D) materials, including graphene, semiconductors (e.g., transition metal dichalcogenides (TMDs)), and black phosphorus (BP), and insulators (e.g., hexagonal boron nitride (hBN)) have been extensively studied due to their splendid electrical, thermal, optoelectrical, and mechanical properties. One of the most significant investigations in 2D materials is in van der Waals heterostructure devices. Multifunctional p–n diodes, ultrasensitive photodetectors, high-performance memories, light-emitting diodes, and bipolar junction transistors have been fabricated from these materials, showing their potential application in future nanoelectronics. Although several studies on BJTs based on 2D van der Waals heterostructures can be found in the literature, these structures have an intricate growth procedure and tedious multistep transfer process making them difficult to fabricate. More importantly, one of the critical factors that influences BJT performance is the difference in the major carrier concentration between the emitter and collector, which has never been explored until now. A BJT can also operate as a phototransistor (where the base is left floating). Photo FETs based on other TMDs have shown large responsivity and...
In this paper, we present a PNP symmetric bipolar junction transistor (SBJT) fabricated with p-type black phosphorus (BP) and n-type MoS$_2$ with femtosecond laser processing (FSLP)\textsuperscript{41–45}. Compared with other intricate growth procedures and tedious transfer processes, we can produce devices with a single stacking step using FSLP. First, this SBJT exhibits a p–n junction rectification ratio of $10^3$ and photoresponsivity of 2.2 A W$^{-1}$. This SBJT exhibits bidirectional electrical amplification output thanks to its symmetric energy band structure since the emitter and collector have the same thickness and crystal orientation. We placed a top gate on one side of the SBJT to change the diode’s symmetric energy band structure and to further investigate the effect of electrostatic doping (i.e., the difference in the major carrier concentration between the emitter and collector) on the device’s performance.

In contrast to FSLP, conventional processing is more complicated and difficult. This method not only includes multistep transfer but also needs to guarantee that the top BP sample cannot contact the bottom BP sample during the transfer. In particular, it is hard to keep the thickness and crystal orientation of the top BP sample consistent with that of the bottom BP sample. Thus, it becomes impractical to further investigate the effect of electrostatic doping (i.e., the difference in the major carrier concentration between the emitter and collector) on the device’s performance.

Fig. 2a shows a schematic of the SBJT. To ensure that our FSLP can completely separate a BP flake, we first fabricated an individual BP device to investigate its optical and electrical properties before and after FSLP. Fig. 2b shows an optical microscope image of the BP device before FSLP. The scanning electron microscope (SEM) images in Fig. 2c and d show that the minimum linewidth can be reduced to 1 $\mu$m, which is confined to our facility and process approach, and we can clearly see that the central region of the BP sample vanished after FSLP. Fig. 2e shows $I$–$V$ curves for such a device. Before FSLP, the device exhibited typical ohmic contact behavior (black line). After FSLP, the device was no longer conductive (red line), indicating that the pristine BP flake was cut into two pieces. An optical microscope image of the SBJT is shown in Fig. 2f. The left and right BP flakes are outlined in blue, MoS$_2$ is outlined in red, and hBN is outlined in green. The thickness of the BP, MoS$_2$, and hBN flake, were measured to be $\sim 7$, $\sim 13$, and $\sim 14$ nm, respectively, using atomic force microscopy.
measurements, as presented in Fig. S3.† We can also see that the BP flake was well preserved and there were no obvious oxidized spots. In addition, considering the thickness dependence of MoS2 (base) for the performance of BJT, there are two reasons for choosing this kind of MoS2 flake as the base layer. First, the thinner base layer is susceptible to electrical breakdown with higher input current or bias voltages; besides, when the device operates in the forward active region, the collector current \(I_C\) would better remain constant. If the base is too thin, the holes from the emitter may overcome the barrier height and contribute to \(I_C\). Second, if the base layer is too thick, which means the increase in the concentration of the majority carrier (electrons) in the base layer, this results in more carriers (jected from the emitter) being recombined with the carriers of opposite polarity in the base layer so that the current amplification gain will be decreased. The similar thicknesses of BP, MoS2 and hBN flakes were used for another sample. Fig. 2g shows the Raman spectra from BP, MoS2, the hBN flake, and the heterojunction. Raman peaks observed at \(\sim361\) cm\(^{-1}\), \(\sim439\) cm\(^{-1}\), and \(\sim466\) cm\(^{-1}\) correspond to \(\text{Ag}^{1}\), \(\text{B}_{2g}^{1}\), and \(\text{A}^{1}\) phonon modes in BP, respectively. The peaks observed at \(\sim383\) cm\(^{-1}\) and \(\sim408\) cm\(^{-1}\) correspond to the \(\text{E}_{2g}^{1}\) and \(\text{A}_{1g}^{1}\) phonon modes of MoS2, respectively. The peaks observed at \(\sim1366\) cm\(^{-1}\) correspond to the \(\text{E}_{2g}^{1}\) phonon modes in hBN. Raman modes from the overlapped region of the stacked hBN/BP (left), BP (left)/MoS2, and BP (right)/MoS2 layers correspond to peaks for each flake, which indicates good film quality in the junction region after exfoliation and dry-transfer. The band structure of the (p-type) BP/(n-type) MoS2/(p-type) BP SBJT are shown in Fig. 2h. The left and right BP regions have the same thickness and crystal orientation, and the major carrier concentration (holes) and band gap in the left BP are the same as those in the right BP, forming a symmetric structure. On this basis, we placed the hBN as the top gate dielectric to modulate the hole concentration in the left BP and break the symmetry and further study the effect of electrostatic doping on the device’s performance.

Next, we investigated the electrical characteristics of the SBJT. All the electrical and optoelectrical measurements were performed at room temperature and in ambient conditions within several hours. First, the basis to ensure the BJT’s performances is the two p-n junctions between the emitter-base and collector-base. \(I-V\) curves from the two p-n junctions \(i.e.,\) the left and right BP/MoS2 regions of the SBJT are shown in Fig. 3a and b, respectively. The insets show these \(I-V\) curves on a log scale. The forward current could be \(\sim10^{-7}\) A, while the reverse current is very small, \(\sim10^{-10}\) A. The p-n junctions exhibit rectification ratios of \(\sim127\) and \(\sim4760\) at \(V_{ds} = -2\) and +2 V, respectively. The ideality factor was calculated with the following equation:

\[
I = I_0(e^{qV/(nkT)} - 1),
\]

where \(I\) is current through the diode, \(V\) is the voltage across the diode, \(I_0\) is the dark saturation current, \(n\) is the ideality factor, \(k\) is the Boltzmann constant, and \(T\) is the absolute temperature. The ideality factors for the left and right BP/MoS2 diodes were calculated to be 2.18 and 1.76, respectively, which are similar to

![Image](70x596 to 525x729)
the values found in previous studies. These results demonstrate that the two p–n junctions with excellent rectifying behaviors were formed in the SJBT. The reason that the right BP/MoS2 diode has a lower ideality factor than the left BP/MoS2 diode may be due to the smaller contact resistance between the right BP and MoS2 samples. Fig. 3c and d show I–V curves from the left and right p–n junctions in the SJBT while illuminated with light from a 532 nm laser with various incident powers (the insets show the photosresponsivity (R) at Vds = 2 V), respectively. The photocurrent increases as the incident light power increases. The photosresponsivity R is defined as Iph/P laser, where Iph is defined as I illumination–I dark, and I illumination and I dark are respectively Ids with and without illumination, and P laser is the incident laser power. Every p–n junction exhibits R values up to 348 mA W–1 and 2.2 A W–1, respectively. Fig. S4† shows I–V curves from the left BP/MoS2 p–n junction under illumination by a 532 nm laser with various incident powers and top gate bias, illustrating its tunable photodetectivity, which will be discussed later.

Under the common-emitter configuration, this SJBT exhibits bidirectional electrical output thanks to its symmetric energy band structure since the emitter and collector have the same thickness and crystal orientation, as shown in Fig. 4. Fig. 4a demonstrates the I–V CE characterizations of the SJBT at various injection currents (Ibs). The inset shows the common-emitter configuration, i.e. the left BP acts as the emitter (ground), MoS2 acts as the base, and the right BP acts as the collector. It is worth mentioning that when the device is operating in the small VCE, it would be in the saturation region, the base-emitter junction and base-collector junction are both in the forward bias, leading to majority carriers in the emitter being injected into the base, and the current increase with the increase in VCE.

The current of the collector increases to 1.8 V, it would be in the forward active region, and only has a relationship with the injection current (Ibs). These results indicate that our device works under ideal conditions, as shown in Fig. 4b. The common-emitter current gain can be defined as β = Ic/Ibs. The common-emitter current gain β versus the collector–emitter voltage (VCE) curves at various injection currents (Ibs) corresponding to Fig. 4a and b are demonstrated in Fig. 4c and d, respectively. The device shows good current gain behaviors and the maximum β were calculated to be ~6 and ~3, respectively. The current gain β of ~6 is not too big but it is comparable to previously reported results.† There are two main reasons for the relatively low current gain. First, the gap size made by laser processing between the emitter and collector may be still large. Second, the doping concentration of the carrier between the p-type BP and n-type MoS2 may not be properly matched. We believe that the performance could be further improved by optimizing the construction of the device, such as shortening the gap width between the emitter and collector. As the gap width becomes narrow, the transit time of the minority hole in the MoS2 (base) decreases, and the probabilities of the recombination of the minority holes and majority electrons are also reduced. As a result, the current gain increases and the device shows better performance. However, there needs to be further investigation on related experiments.

We noticed that when the left BP acts as the emitter, the output amplification abilities are better as compared to when the right BP acts as the emitter, which may also be attributed to the smaller contact resistance between the right BP and MoS2 samples. To verify the stability of the devices, we performed similar electrical output measurements after two months as shown in Fig. S3.† During this time, we kept this device in a glove box filled with N2. We observed that the two p–n junctions still showed good rectifying behaviors, as demonstrated in Fig. S5a and b.† The bidirectional electrical amplification output characterizations under common-emitter configuration are also exhibited in Fig. S5c and d† and these results indicate that our device has good stability. Usually, as the doping concentration in the emitter increases, the output current increases.† Therefore, we placed a top gate on one side of the SJBT to further investigate the effect of electrostatic doping on the device’s performance. In our device, the top gate applied on the left black phosphorus (emitter) is a high κ hBN dielectric with a thickness of ~14 nm, therefore, the gate-tunable behavior is more effective and comprehensive. Fig. S6† shows the gate-tunable I–V curves and corresponding band diagrams when the SJBT is operated in the forward active mode. The common-base configuration is shown.
in Fig. S6a.† The left BP acts as the emitter, MoS2 acts as the base (ground), and the right BP acts as the collector. The top gate was placed on the left BP (emitter). We observed that the collector current $I_C$ decreased regardless of the gate voltage decrease or increase (Fig. S6b and c†), which is not consistent with our expectations. Fig. S6d–f† shows a schematic and band diagrams of the gate-tunable SBJT in the forward active mode with zero, negative, and positive gate modulation, respectively.

We can explain this kind of current transport in the SBJT with the energy band models. Under negative gate modulation, although the concentration of holes in the emitter increases, the barrier’s height between the emitter/base increases and thus few holes can cross the left BP/MoS2 junction and be collected by the right BP, and the output current decreases. Under positive gate modulation, the height of the barrier decreases. However, the concentration of holes in the emitter decreases and thus few holes can cross the left BP/MoS2 junction and be collected by the right BP, yielding a smaller current. More details are presented in the ESI (Fig. S6†). Similar results were obtained in another SBJT. Fig. S7a† shows an optical microscope image of another SBJT. Fig. S7b and c† show $I$–$V$ curves from the left and right BP/MoS2 p–n junctions in another SBJT (the insets show $I$–$V$ curves on a log scale), respectively. Typical rectifying behaviors in the p–n junction were observed at the two junctions with rectification ratios of $\sim 35$ and $\sim 37$ at $V_{ds} = -2$ and $+2$ V, respectively. For another SBJT, the left BP acts as the emitter, MoS2 acts as the base (ground), and the right BP acts as the collector, as was the case in the SBJT discussed in the ESI.† Fig. S8† shows the gate-tunable $I$–$V$ curves of this second SBJT. The output current decreases when the gate is positively or negatively modulated. Therefore, there is something meaningful in the collector current phenomenon $I_C$ and we can conclude that the top gate on the emitter affects the carrier concentration in the emitter and modulates the band alignment between the emitter and base. To get better performance, optimized devices and experiments should be implemented.

Our SBJT can also operate as a phototransistor with gate-tunable photocurrent amplification when the base is left floating. Two important parameters for evaluating
a phototransistor are its photoresponsivity \( R \) and gain \( \beta \). \( \beta \) is defined as \( \beta_{\text{photo}} = I_{ds}/I_{pn} \) for a given level of illumination,\(^{42,44}\) when the base is left floating; \( I_{ds} \) is the two-terminal current measured between the left and right BP regions. The gain here is in reference to the photocurrent generated in the left BP/MoS\(_2\) p–n diode \( (I_{pn}) \), which we measured previously. The gate-tunable photovoltaic properties of the phototransistor are shown in Fig. 5. Fig. 5a shows \( I\text{–}V \) curves of the phototransistor illumination with a 532 nm laser at various incident powers with \( V_{g} = 0 \) V. The photocurrent increases as the input illumination increases, which is attributed to the increased photoinduced carrier concentration. The insets show a schematic of the gate-tunable phototransistor and the photoresponsivity \( R \) of the device at various incident laser powers with \( V_{ds} = 2 \) V and \( V_{g} = 0 \) V. The value \( R = 151 \) mA W\(^{-1}\) was calculated at \( P = 100 \) mW. The gate-tunable \( I\text{–}V \) curves from the illuminated phototransistor can be seen in Fig. S9.\(^{\dagger}\) Fig. 5b shows the gate-tunable photoresponsivity \( R \) at various incident powers with \( V_{ds} = 2 \) V. A maximum photoresponsivity of \( R = 151 \) mA W\(^{-1}\) was observed at zero gate bias. Similar to the case demonstrated in Fig. S6,\(^{\dagger}\) the photocurrent decreases when the gate voltages decrease due to higher barrier at the emitter-base junction, while increasing the gate voltage decreases the holes’ concentration, which also decreases the photocurrent. The gate-tunable optical gain \( \beta \) with varying \( V_{ds} \) is shown in Fig. 5c, and maximum gain of \( \beta \approx 21 \) was found at \( V_{g} = 0 \) V; although this result is not very outstanding, it is better than that of other bipolar phototransistors,\(^{40,42,49,50}\) as shown in Table 1. The maximum \( \beta \) value was also observed at zero gate bias for the same reason stated above. Scanning photocurrent images (SPI) were gathered at zero gate bias and while the device was illuminated with 532 nm laser light in order to determine the mechanism governing the photocurrent amplification. Fig. 5d shows the SPI and corresponding schematic diagram of the device at \( V_{ds} = 2 \) V. Apparent photocurrent signals can be observed at the interface between the left BP region and MoS\(_2\), as shown in Fig. 5d(i). Under forward bias, holes were driven from the left BP region to right BP region by the electric field, forming a forward current. When the left BP/MoS\(_2\) interface region was illuminated, photoinduced electron–hole pairs will be separated by the electric field at the junction, and holes flow into the base and increase the photocurrent, as shown in Fig. 5d(ii). On the other hand, although there are photoinduced electron–hole pairs at the right BP/MoS\(_2\) junction when this region is excited, the separated electrons will recombine with holes from the base, which does not affect photocurrent amplification, as shown in Fig. 5d(iii). Fig. 5e shows the SPI and corresponding schematic diagram of the device at zero bias. Due to the photovoltaic effect, the photoinduced electron–hole pairs will separate into free charges at the p–n interface and form a photocurrent driven by the built-in electric field. The two p–n junctions have mirror symmetry and thus, two opposite photocurrents can be observed at the left and right BP/MoS\(_2\) interface regions. Fig. 5f(i) shows the SPI from the device at \( V_{ds} = -2 \) V. One can see that the strongest photosresponse occurs at the right BP/MoS\(_2\) interface, which is attributed to photoinduced carriers at the junction. The symmetric structure of our phototransistor can be explained as illustrated in Fig. 5d. The photogenerated electron–hole pairs will be separated by the electric field at the right BP/MoS\(_2\) junction when this region is excited; holes move into the base and amplify the backward photocurrent, as shown in Fig. 5f(ii). When the left BP/MoS\(_2\) interface region is illuminated, photoinduced electron–hole pairs will be separated by the electric field at the junction; separated electrons will recombine with holes in the base, leading to very low photocurrent (Fig. 5f(iii)). The gate-tunable SPI from the phototransistor are shown in Fig. S10.\(^{\dagger}\) In spite of the various gate bias values, the photocurrent is primarily concentrated in the same location for a given bias. The strongest photocurrent was measured when the gate was held at 0 V, and the photosresponse decreased gradually when the gate bias was non-zero. These phenomena also occur due to the broken symmetry at non-zero gate bias.

**Conclusions**

In summary, we presented a symmetric PNP SBJT fabricated from p-type BP and n-type MoS\(_2\) with FSLP. Compared with other intricate growth procedures and tedious transfer processes, we can produce BJT with a single stacking step with the advantage of femtosecond laser processing. On this basis, femtosecond laser processing allows us to reduce the cost and time of the fabrication process, improve the success rate of the device fabrication. This SBJT exhibits a rectification ratio of \( 10^7 \) and photoresponsivity of 2.2 A W\(^{-1}\). This SBJT exhibits bi-directional electrical output due to its symmetric band structure since the emitter and collector have the same thickness and crystal orientation. Moreover, this SBJT can act as a kind of phototransistor with maximum photoresponsivity of \( R = 151 \) mA W\(^{-1}\) and maximum photocurrent gain of \( \beta \approx 21 \). Better performance could be further achieved by optimizing the construction of the device, such as shortening the gap width between the emitter and collector. Scanning photocurrent images (SPI) were used to determine the mechanism governing photocurrent amplification in the SBJT. These results illustrate a novel, convenient method for fabricating multifunctional hetrostructure devices.

**Experimental section**

**Fabrication of symmetric bipolar junction transistor**

Black phosphorus thin flakes of uniform thickness were mechanically exfoliated using adhesive tape (3M Scotch) from

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**Table 1** Comparison of photocurrent gains in this work and other previously reported phototransistor devices

<table>
<thead>
<tr>
<th>Material</th>
<th>Type</th>
<th>Structure</th>
<th>( \beta )</th>
<th>Ref.</th>
</tr>
</thead>
<tbody>
<tr>
<td>Au/graphene/MoS(_2)</td>
<td>NPN</td>
<td>3D</td>
<td>~18</td>
<td>49</td>
</tr>
<tr>
<td>Si/Ge/Si</td>
<td>NPN</td>
<td>3D</td>
<td>~7</td>
<td>40</td>
</tr>
<tr>
<td>MoS(_2)/BP/WSe(_2)</td>
<td>NPN</td>
<td>2D</td>
<td>~9.8</td>
<td>42</td>
</tr>
<tr>
<td>MoS(_2)</td>
<td>NPN</td>
<td>2D</td>
<td>~23</td>
<td>50</td>
</tr>
<tr>
<td>BP/MoS(_2)/BP</td>
<td>PNP</td>
<td>2D</td>
<td>~21</td>
<td>This work</td>
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</tbody>
</table>
bulk BP crystals (XFNANO, Inc) on a clean SiO$_2$/Si substrate. The thickness of SiO$_2$ on the p-doped Si substrate was ~285 nm. FSLP (800 nm, 35 fs, and 30 mW) was used to cut the BP flake into two pieces. More details regarding FSLP are given in Fig. S1.† A MoS$_2$ flake was bridged onto the two BP pieces using a dry-transfer technique with a micromanipulator and an optical microscope. Subsequently, an hBN flake was transferred onto the left BP flake as the top gate dielectric in the same way. Afterwards, 50 nm Au electrodes were patterned using photolithography with the femtosecond laser (800 nm, 35 fs) and deposited using magnetron sputtering (JZCK-465 of Sky Technology Development). Fig. S2† shows the corresponding optical microscope images of the SBJT after each fabrication step. Finally, vacuum thermal annealing (320 °C for 1 h) was performed to achieve good contact.

Characterizations

Raman spectroscopy and AFM were measured using a confocal Raman/AFM system (Alpha 300 R, WITec). Raman spectroscopy was conducted using a 532 nm laser with power of 3 mW (integration time of 30 s and number of accumulations of 5), and the resolution of the fine Raman spectrum was above 0.1 cm$^{-1}$.

Electrical and optoelectrical measurements

All the electrical and photoresponse measurements were gathered under ambient conditions and at room temperature. The electrical and optoelectrical characteristics were measured with a semiconductor parameter analyzer (Keithley 4200A), and the SPI were gathered with digital source-measure units (Keithley 2400 and 2450A), and the resolution of the SPI were gathered with digital source-measure units with a semiconductor parameter analyzer (Keithley 4200A), and the resolution of the SPI were gathered with digital source-measure units (Keithley 2400 and 2450A), and the resolution of the SPI were gathered with digital source-measure units (Keithley 2400 and 2450A), and the resolution of the SPI were gathered with digital source-measure units (Keithley 2400 and 2450A), and the resolution of the SPI were gathered with digital source-measure units (Keithley 2400 and 2450A).

Conflicts of interest

There are no conflicts to declare.

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